

SMD ■ A

95-21SURC/S530-A3/TR9



Features

- Package in 12mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- EIA Std. package.
- Mono-color type.
- Pb-free.
- RoHS compliant
- Compliance with EU REACH.
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm)

Description

The 95-21 SMD LED is much smaller than leaded components .
Thus enable smaller board size. Higher packing density. Reduced storage space
and finally smaller equipment to be obtained.

Applications

- .Small indicator for indoor applications.
- .Flat backlight for LCD, switches and symbols.
- .Indicator and backlight in office equipment.
- .Indicator and backlight for battery driven equipment.
- .Indicator and backlight for audio and video equipment.
- .Backlighting in dashboards and switches.
- .Telecommunication : indicator and backlighting in telephone and fax.

Device Selection Guide

Chip Materials	Emitted Color	Resin Color
AlGaInP	Brilliant Red	Water Clear

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V _R	5	V
Forward Current	I _F	25	mA
Peak Forward Current (Duty 1/10 @1KHz)	I _{FP}	60	mA
Power Dissipation	P _d	60	mW
Operating Temperature	T _{opr}	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +90	°C
Electrostatic Discharge	ESD _{HBM}	2000	V
Soldering Temperature	T _{sol}	Reflow Soldering : 260 °C for 10 sec. Hand Soldering : 350 °C for 3 sec.	

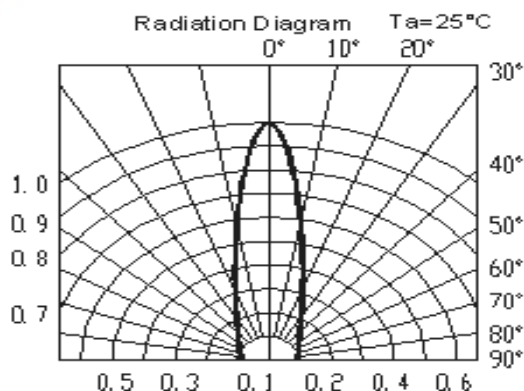
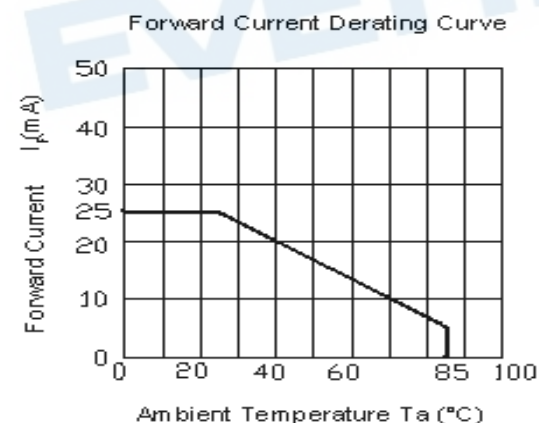
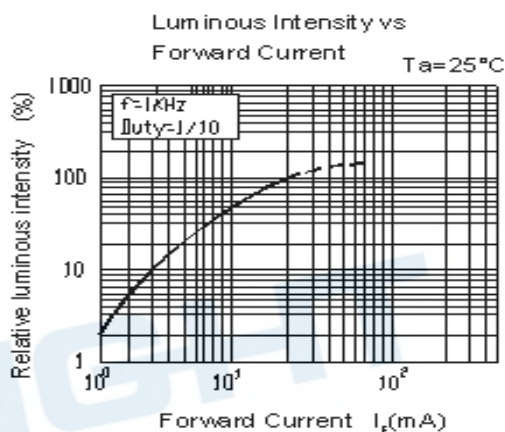
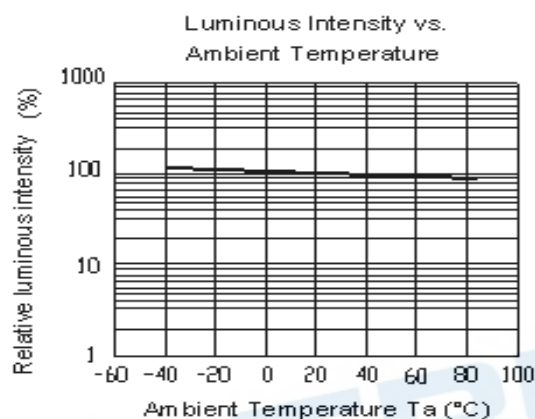
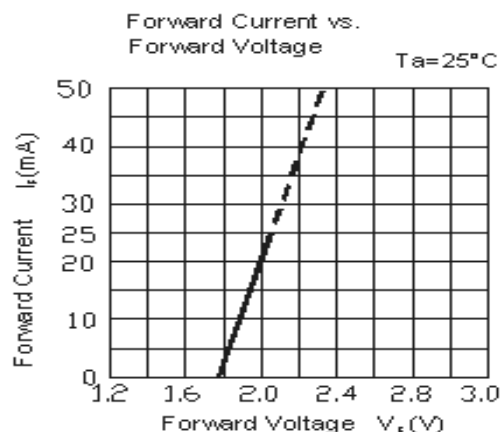
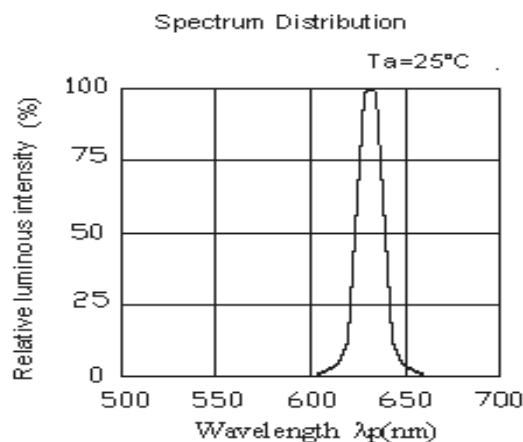
Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	I _v	400	600	-----	mcd	I _F =20mA
Viewing Angle	2θ _{1/2}	-----	25	-----	deg	
Peak Wavelength	λ _p	-----	632	-----	nm	
Dominant Wavelength	λ _d	-----	624	-----	nm	
Spectrum Radiation Bandwidth	Δλ	-----	20	-----	nm	
Forward Voltage	V _F	1.7	2.0	2.4	V	V _R =5V
Reverse Current	I _R	-----	-----	10	μA	

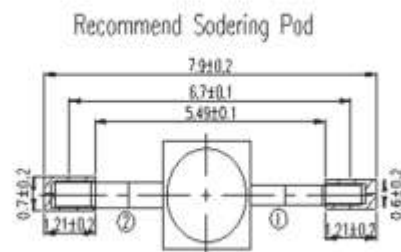
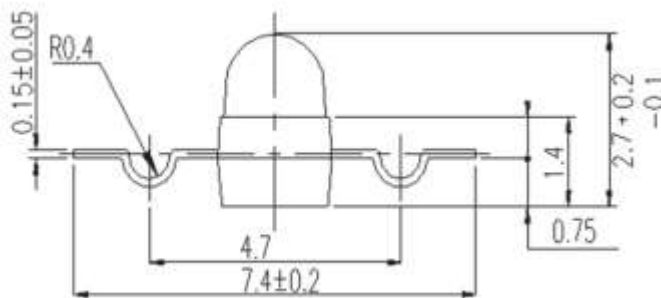
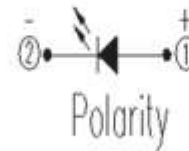
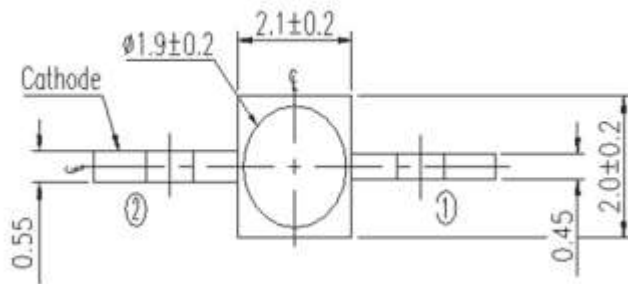
Notes:

1. Reverse Voltage(V_R) Condition is applied to I_R test only The device is not designed for reverse operation

Typical Electro-Optical Characteristics Curves



Package Outline Dimensions



Suggested pad dimension is just for reference only.
Please modify the pad dimension based on individual need.

Note: The tolerances unless mentioned are ± 0.1 , unit=mm.

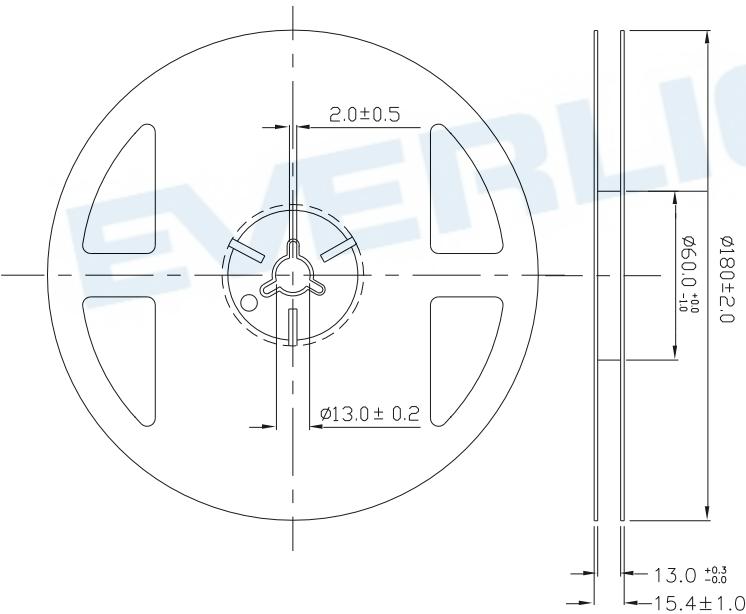
Moisture Resistant Packing Materials

Label Explanation



- CPN: Customer's Product Number
- P/N: Product Number
- LOT No: Lot Number
- QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Dom. Wavelength Rank
- REF: Forward Voltage Rank

Reel & Carrier Tape Dimensions

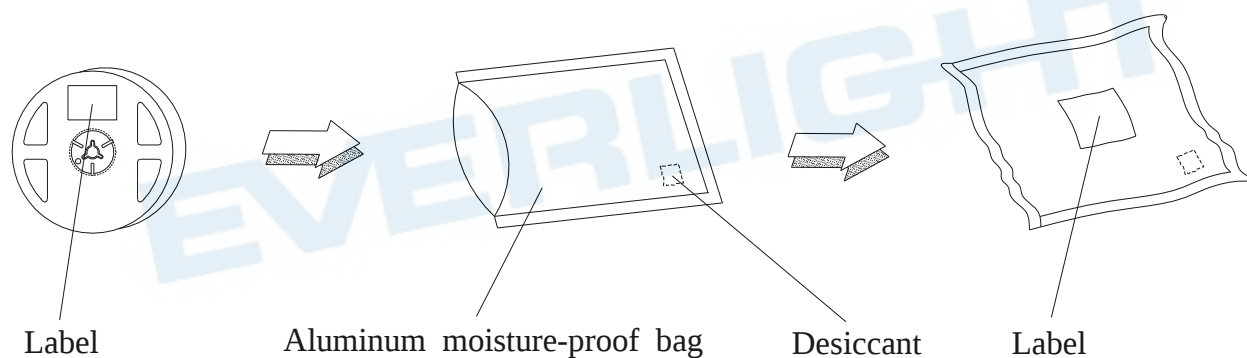


Note: The tolerances unless mentioned are ± 0.1 , unit=mm.

Technical drawing of the top tape showing dimensions and assembly details. The drawing includes a top view and a side view. Key dimensions and features are labeled:

- Dimensions:**
 - 15 $\pm$ 0.1
 - 4.0 $\pm$ 0.1
 - 2.0 $\pm$ 0.05
 - 1.75 $\pm$ 0.1
 - 5.5 $\pm$ 0.05
 - 12.0 $\pm$ 0.3
 - 3.15 $\pm$ 0.1
 - 0.36 $\pm$ 0.02
 - 4.0 $\pm$ 0.1
- Labels:**
 - Polarity (with a diode symbol)
 - TOP TAPE
 - FEED DIRECTION (indicated by an arrow)
 - PUSH PIN THROUGH HOLE

Moisture Resistant Packaging



Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.

2.3 After opening the package: The LED's floor life is 72 hours under 30°C or less and 60% RH or less.

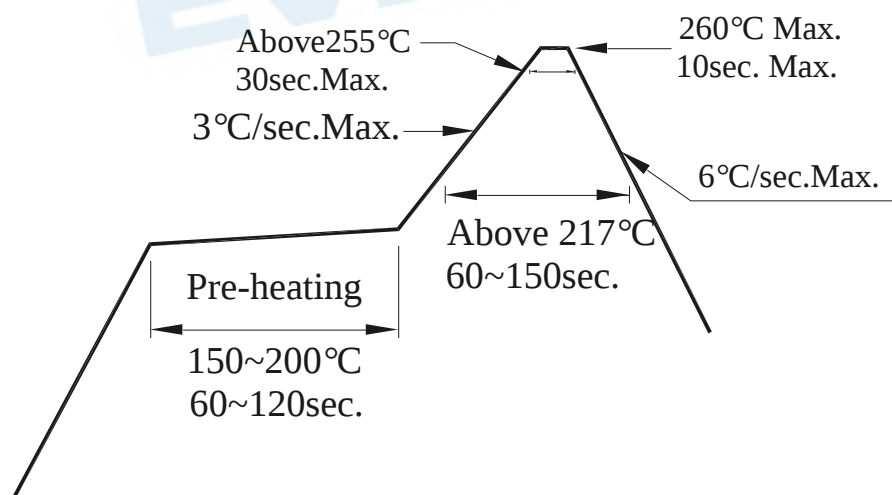
If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

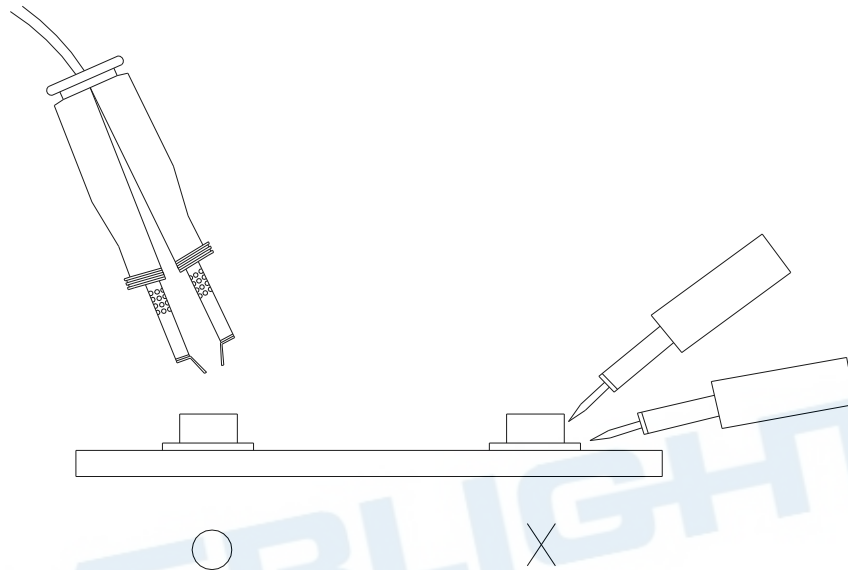
3.4 After soldering, do not warp the circuit board.

4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



DISCLAIMER

1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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